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CONFIRMATION NO. 3352

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|-----------------------------|---------------------------------------|--------------|------------------------|------------------------------------|
| SERIAL NUMBER<br>10/797,923 | FILING DATE<br>03/10/2004<br><br>RULE | CLASS<br>257 | GROUP ART UNIT<br>2826 | ATTORNEY<br>DOCKET NO.<br>FUJI:300 |
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APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\*  
*Note - TD*

\*\* FOREIGN APPLICATIONS \*\*\*\*\*  
 JAPAN JP 2003-129541 05/07/2003 *TD*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED  
 \*\* 05/27/2004

|   |   |                              |                        |                       |                            |
|---|---|------------------------------|------------------------|-----------------------|----------------------------|
| Foreign Priority claimed<br>35 USC 119 (a-d) conditions met | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no<br><input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance | STATE OR<br>COUNTRY<br>JAPAN | SHEETS<br>DRAWING<br>6 | TOTAL<br>CLAIMS<br>13 | INDEPENDENT<br>CLAIMS<br>3 |
|---|---|------------------------------|------------------------|-----------------------|----------------------------|

Verified and Acknowledged  
 Examiner's Signature *[Signature]* Initials *TD*

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TITLE  
 Semiconductor wafer, semiconductor device, and process for manufacturing the semiconductor device

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|------------------------------------|---|--|
| FILING FEE<br><br>RECEIVED<br>1300 | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue )<br><input type="checkbox"/> Other _____ |
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